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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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10/064,301

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Jeffrey S. Brown

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EXAMINER

NGUYEN, THANH T

ART UNIT

PAPER NUMBER

2813

DATE MAILED: 10/24/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/064,301

Applicant(s) 

BROWN ET AL.

Examiner

Thanh T. Nguyen

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-- The MAILING DATE of this communication appears on the cover sheet with the corresponding address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 20 September 2002.
- 2a) ☐ This action is FINAL. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-20 is/are pending in the application.
- 4a) Of the above claim(s) 11-20 is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-10 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☒ The drawing(s) filed on 01 July 2002 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on _____ is: a) ☐ approved b) ☐ disapproved by the Examiner.
- If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

Priority under 35 U.S.C. §§ 119 and 120

- 13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
- a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☒ Information Disclosure Statement(s) (PTO-1449) Paper No(s) 2.
- 4) ☐ Interview Summary (PTO-413) Paper No(s). _____.
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other: _____.

DETAILED ACTION

Election/Restrictions

Applicant's election without traverse of claims 1-10 in Paper No. 4 is acknowledged.

Claims 11-20 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected without traverse, there being no allowable generic or linking claim. Election was made **without** traverse in Paper No. 4.

Oath/Declaration

Oath/Declaration filed on July 1, 2002 has been considered.

Information Disclosure Statement

The information disclosure statement (IDS) filed on 7/1/02 has been considered by the examiner.

Specification

The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.

The following title is suggested: --Structure for scalable, low-cost polysilicon capacitor in planar DRAM--.

Claim Objections

Claim 1 is objected to because of the following informalities:

In claim 1, line 1 “a substrate” and in claim 1, line 4 “a semiconductor substrate” lack clarity in providing one substrate for a structure which applicant regards as the invention.

Changing “a substrate” in claim 1, line 1 to “a semiconductor substrate”, and changing “a semiconductor substrate” in claim 1, line 4 to “the semiconductor substrate” or “the substrate” is suggested.

Appropriate correction is required.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1-5 and 7 are rejected under 35 U.S.C. 102(b) as being anticipated by Cunningham (U.S. Patent No. 6,177,697).

Referring to figures 1-3B, Cunningham teaches a structure formed on a substrate comprising:

a plurality of isolation filled trenches (10) in the substrate (28/6, see figure 1 and col. 4, lines 39-61),

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a plurality of holes (18, called "trench" in Cunningham) in the substrate (28/6), each having a plurality of sidewalls and a bottom wall (see figures 1, 2, and col. 4, lines 62-65), located in a region of a semiconductor substrate in which the plurality of isolation filled trenches (10) are absent, holes (18) having a depth proximate that of plurality of isolation filled trenches (10, see figure 1 and col. 6, lines 50-54),

insulating material (16, see col. 4, lines 40-41) present in each of the plurality of holes (18) on the plurality of sidewalls and bottom wall; and

a conductor (22/23, see col. 6, lines 4-5) overfilling each of holes (18) and extending onto an adjacent upper surface of the substrate (28/6, see figure 1),

regarding to claim 2, a counter-doped region (6a, see figure 1 and col. 5, lines 58-63, and col. 6, lines 14-22, since region 6a having p-type dopant which is opposite to the n-type well region 28, hence region 6a is a counter-doped region) present in pillar regions of the semiconductor substrate (28/6) that surround the holes (18),

regarding to claim 3, a well region (28) located in semiconductor substrate (28/6),

regarding to claims 4 and 5, a transfer device (19, a field effect transistor, i.e. a gate electrode 19 formed on a gate oxide layer 16 having LDD source/drain regions p+, see col. 6, lines 3-13) located atop a surface of the semiconductor substrate (28/6) adjoining the plurality of holes (18),

regarding to claim 7, insulating material (16) is disposed on the upper surface of the substrate (28/6) beneath portions of conductor (22/23).

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 6 and 9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Cunningham (U.S. Patent No. 6,177,697) as applied to claims 1-5 and 7 above, further in view of Satoh (U.S. Patent No. 5,183,774).

Cunningham teaches an isolation trench (10) and holes (18) for capacitor in figure 1. However, Cunningham does not teach the insulating material is thicker on the bottom wall of the plurality of holes than on the plurality of sidewall of the plurality of holes, and an isolation dopant region is disposed below the bottom walls of the plurality of holes (as claimed in claims 6 and 9). Nevertheless, the insulating material is thicker on the bottom wall of the plurality of holes than on the plurality of sidewalls of the plurality of holes, and an isolation dopant region is disposed below the bottom walls of the plurality of holes is known in semiconductor art as evidenced by Satoh. Satoh teaches an insulating material (37, see figures 3D-3E and col. 5, lines 1-3) is thicker on the bottom wall of the plurality of holes (33, called "trench" for a capacitor in Satoh) than on the plurality of sidewalls (23) of the plurality of holes (33), and an isolation dopant region (36, called an "impurity layer" in Satoh) is disposed below the bottom walls of the plurality of holes (33, figures 3D-3E and col. 4, lines 65-68). Therefore, it would have been obvious to a person of ordinary skill in the art at the time of the invention was made would have

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an insulating material thicker on the bottom wall of the plurality of holes than on the plurality of sidewalls of the plurality of holes, and an isolation dopant region is disposed below the bottom walls of the plurality of holes in the device of Cunningham as taught by Satoh *because* a thicker insulating material formed on the bottom of capacitor holes (trenches) and an isolation dopant region formed below the bottom wall of capacitor holes (trenches) would provide an isolating region to prevent the charges which are stored in the capacitor from leaking into substrate.

Claims 8 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Cunningham (U.S. Patent No. 6,177,697) as applied to claims 1-5 and 7 above, further in view of Tang (U.S. Patent No. 6,437,369).

Cunningham teaches an isolation trench (10) and holes (18) for capacitor in figure 1. However, Cunningham does not teach the holes have a depth greater than the plurality of isolation-filled trenches, the substrate has a buried insulation region and the plurality of holes extend into the buried insulation region (as claimed in claims 8 and 10). Nevertheless holes having a depth greater than the plurality of isolation-filled trenches, the substrate has a buried insulation region and the plurality of holes extend into the buried insulation region is known in semiconductor art as evidenced by Tang. Tang teaches holes (30, called "capacitor openings" in Tang, see figures 7-8 and col. 4, lines 5-23) have a depth greater than the plurality of isolation-filled trenches (24, see figures 2 and 7, and col. 3, lines 60-65, capacitor openings 30 are provided through SOI layer 16 into capacitor cell plate substrate 12 while isolation trench 24 is stop at insulating layer 14) and the substrate has a buried insulation region (14, beneath the semiconductive layer 16) and the plurality of holes (30) extend into the buried insulation region (14, see figure 7). Therefore, it would have been obvious to a person of ordinary skill in the art

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at the time of the invention was made would have capacitor holes having a depth greater than the plurality of isolation-filled trenches, and the substrate has a buried insulation region and the plurality of holes extend into the buried insulation region in the device of Cunningham as taught by Tang *because* a deeper capacitor hole would provide more capacitor area for storing charges, and buried insulating layer would provide more isolation for capacitor cell to prevent storage charges from leaking into substrate when capacitor hole extended into the buried insulating.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Thanh Nguyen whose telephone number is (703) 308-9439, or by Email via address Thanh.Nguyen@uspto.gov. The examiner can normally be reached on Monday-Thursday from 6:30AM to 4:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl Whitehead, can be reached on (703) 308-4940. The fax phone number for this Group is (703) 308-7722.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956 (See **MPEP 203.08**).



Thanh Nguyen
Patent Examiner
Patent Examining Group 2800

October 10, 2002
TTN